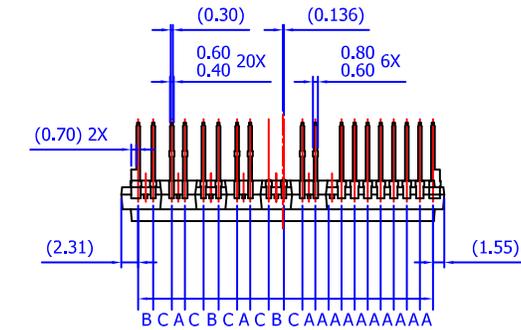
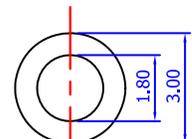
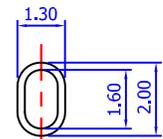
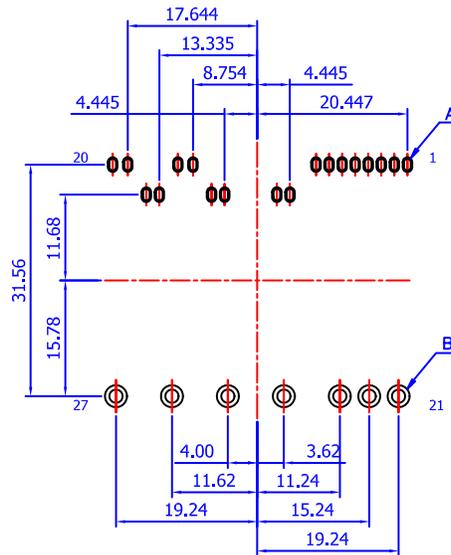
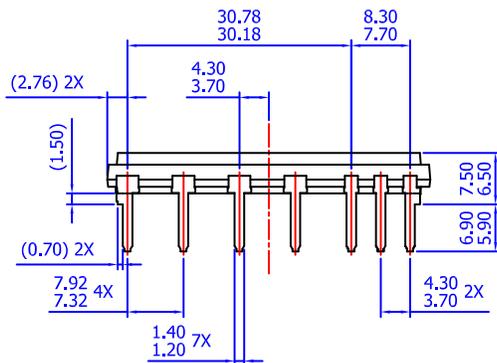
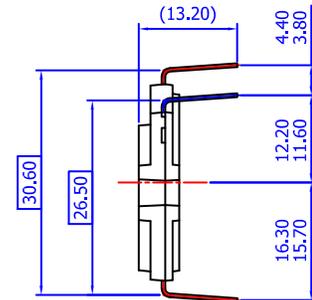
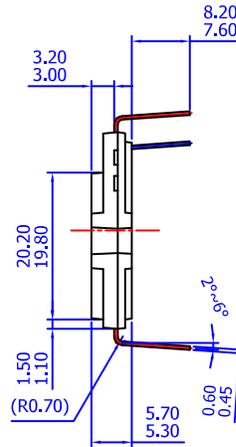
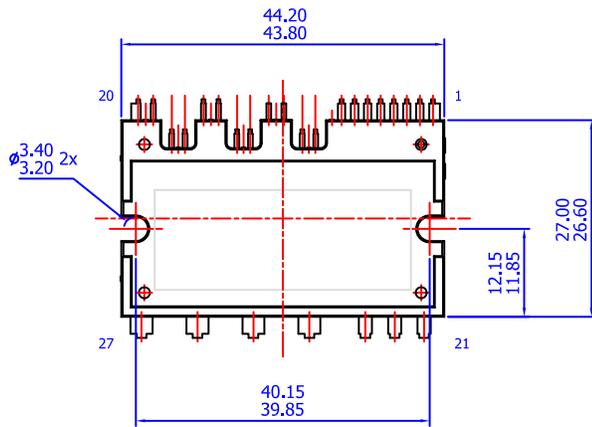


SPMIA-027 / 27LD, PDD, BOOST PFCM SPM27-IA
CASE MODDJ
ISSUE O

DATE 31 DEC 2016



LEAD PITCH (TOLERANCE : ±0.30)
A : 1.778
B : 2.050
C : 2.531



- NOTES: UNLESS OTHERWISE SPECIFIED
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 B) ALL DIMENSIONS ARE IN MILLIMETERS
 C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
 D) () IS REFERENCE
 E) [] IS ASS'Y QUALITY

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